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U.S. Department of Commerce Patent and Trademark Office

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To the Honorable Commissioner of Pa.	10031	230
To the Hohorable Commissioner of Factorial		

Lhed original documents or copy thereof.

1. Name of conveying party(ies):	2. Name and Address of receiving party(ies)
Micron Custom Manufacturing Services, Inc.	MCMS, Inc. 16399 Franklin Road  Name Idaha 82697
Additional name(s) of conveying party(ies) attached?Yes _X_No	Nampa, Idaho 83687
3. Nature of conveyance:	2. ~ 19
Assignment Merger	
Security Agreement Change of Name	<u></u>
_X_ Other <u>Correction - Delete incorrect serial number</u> 08/775,664 from Reel/Frame 9138/0209 and record change of name against new serial number	Additional name(s) & address(es) attached?YesX_No
Execution Date: February 18, 1998	
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the ex	secution date of the application is:
A. Patent Application No.(s)	B. Patent No.(s)
08/775,644	
Additional numbers attach	ed?Yes _X_ No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Hayley M. Smith, Legal Assistant Kirkland & Ellis	7. Total fee (37 CFR 3.41) \$ <u>40.00</u>
Citicorp Center 153 East 53rd Street	Enclosed
New York, New York 10022	Any deficiency is authorized to be charged to

**02/24/1999 TTDN11** 

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(212) 446-4727

8. X Charge to Deposit Account No. 11-1098

Deposit Account No. 11-1098

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Debra B. Arenare, Esq. Name of Person Signing Signature

February 18, 1999 Date

Total number of pages including cover sheet, attachments, and document:

# State of Idaho

# **Department of State**

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I, PETE T. CENARRUSA, Secretary of State of the State of Idaho, hereby certify that I am the custodian of the corporation records of this State.

I FURTHER CERTIFY That the annexed is a full, true and complete transcript of articles of amendment of MCMS, INC., an Idaho corporation, changing its name from MICRON CUSTOM MANUFACTURING SERVICES, INC., received and filed in this office on February 18, 1998, under file number C 108686, as appears of record in this office as of this date.

Dated: March 4, 1998



Fite of Enaveuse SECRETARY OF STATE

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#### CERTIFICATE OF AMENDMENT OF

#### ARTICLES OF INCORPORATION OF

## MICRON CUSTOM MANUFACTURING SERVICES, INC.

The undersigned, Jess Asla and Dena Banducci, certify that:

- They are the duly elected Vice President, Operations and Secretary, respectively, of Micron Custom Manufacturing Services, Inc., an Idaho corporation (the "Corporation").
- 2. Article I of the Articles of Incorporation of the Corporation is hereby amended to read as follows:

"The name of the Corporation is: MCMS, Inc."

- The foregoing Amendment of the Articles of Incorporation has been duly approved by the Board of Directors of the Corporation by unanimous written consent effective as of February 18, 1998.
- 4. The foregoing Amendment of the Articles of Incorporation has been duly approved by the holders of all of the outstanding shares of common stock of the Corporation by unanimous written consent effective as of February 18, 1998.

We further declare under penalty of perjury under the laws of the State of Idaho that the matters set forth in this amendment are true and correct to our own knowledge.

Date: February 18, 1998

Jess Asla, Vice President, Operations

Dena Banducci, Secretary

#### **ACTION BY WRITTEN CONSENT OF**

#### THE SOLE SHAREHOLDER OF

# MICRON CUSTOM MANUFACTURING SERVICES, INC.

The undersigned, being the sole shareholder of Micron Custom Manufacturing Services, Inc. (the "Corporation"), in accordance with the Bylaws of the Corporation and the Idaho Business Corporation Act, hereby adopts the following resolution:

Resolved: That Article I of the Articles of Incorporation of the Corporation is amended to read in full as follows:

"The name of the Corporation is: MCMS, Inc."

Resolved Further: That the Corporation is authorized to take all such actions as are necessary or advisable in order to carry out the intent of the foregoing resolution.

In witness whereof, the undersigned has executed this Consent as of the 18th day of February, 1998.

MEI CALIFORNIA, INC.

PATENT

**REEL: 9777 FRAME: 0393** 



# UNITED STATES DEPARTMENT OF COMMERCE Patent and Trademark Office

ASSISTANT SECRETARY AND COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

JUNE 30, 1998

PTAS

KIRKLAND & ELLIS
HAYLEY M. SMITH, LEGAL ASSISTANT
CITICORP CENTER
153 EAST 53RD STREET
NEW YORK, NEW YORK 10022



UNITED STATES PATENT AND TRADEMARK OFFICE NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT DIVISION OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE MICROFILM COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE EMPLOYEE WHOSE NAME APPEARS ON THIS NOTICE AT 703-308-9723. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, ASSIGNMENT DIVISION, BOX ASSIGNMENTS, CG-4, 1213 JEFFERSON DAVIS HWY, SUITE 320, WASHINGTON, D.C. 20231.

RECORDATION DATE: 04/23/1998 REEL/FRAME: 9138/0209

NUMBER OF PAGES: 7

BRIEF: CHANGE OF NAME (SEE DOCUMENT FOR DETAILS).

ASSIGNOR:

MICRON CUSTOM MANUFACTURING DOC DATE: 02/18/1998

SERVICES, INC.

ASSIGNEE:

MCMS, INC.

16399 FRANKLIN ROAD NAMPA, IDAHO 33687

SERIAL NUMBER: 08800069 FILING DATE: 02/12/1997

PATENT NUMBER: ISSUE DATE:

SERIAL NUMBER: 08602346 FILING DATE: 02/16/1996 PATENT NUMBER: 5755471 ISSUE DATE: 05/26/1998

SERIAL NUMBER: 08410388 FILING DATE: 03/27/1995

PATENT NUMBER: ISSUE DATE:

SERIAL NUMBER: 08686781 FILING DATE: 07/26/1996 PATENT NUMBER: 5775568 FISUE DATE: 07/07/1998

# 9138/0209 PAGE 2

SERIAL NUMBER: PATENT NUMBER:	08553763	
SERIAL NUMBER: PATENT NUMBER:	0889195 <b>4</b>	FILING DATE: 07/14/1997 ISSUE DATE:
	08712371 5757201	ISSUE DATE: 05/26/1998
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 08/12/1996 ISSUE DATE: 08/11/1998
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 09/03/1996 ISSUE DATE: 04/21/1998
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 12/31/1996 ISSUE DATE: 07/21/1998
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SERIAL NUMBER: PATENT NUMBER:	08772155	ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 12/20/1996 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 05/13/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 06/30/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08885670	FILING DATE: 06/30/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 08/22/1997 ISSUE DATE:
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SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 04/10/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08895765	FILING DATE: 07/17/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 07/17/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 06/25/1997 ISSUE DATE:

# 9138/0209 PAGE 3

9138/0209 PAGE	3	
	08882480	
SERIAL NUMBER: PATENT NUMBER:	08852335	FILING DATE: 05/07/1997 ISSUE DATE:
	08897093	
SERIAL NUMBER: PATENT NUMBER:	08925188	FILING DATE: 09/08/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08926139	FILING DATE: 09/09/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08919626	FILING DATE: 08/28/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08919536	FILING DATE: 08/28/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:	08924278	FILING DATE: 09/05/1997 ISSUE DATE:
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 02/21/1989 ISSUE DATE: 12/12/1989
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 10/25/1991 ISSUE DATE: 09/28/1993
SERIAL NUMBER: PATENT NUMBER:	07802310 5237622	FILING DATE: 12/04/1991 ISSUE DATE: 08/17/1993
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 09/24/1993 ISSUE DATE: 07/18/1995
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 01/10/1994 ISSUE DATE: 01/31/1995
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 04/12/1995 ISSUE DATE: 07/30/1996
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 03/20/1995 ISSUE DATE: 07/16/1996
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 10/14/1994 ISSUE DATE: 07/30/1996
SERIAL NUMBER: PATENT NUMBER:		FILING DATE: 07/03/1995 ISSUE DATE: 04/08/1997

PATENT **REEL: 9777 FRAME: 0396**  9138/0209 PAGE 4

SERIAL NUMBER: 08639354 FILING DATE: 04/26/1996 PATENT NUMBER: 5667077 ISSUE DATE: 09/16/1997

SERIAL NUMBER: 08801996 FILING DATE: 02/18/1997 PATENT NUMBER: 5704535 FILING DATE: 01/06/1998

ANTIONE ROYALL, EXAMINER ASSIGNMENT DIVISION OFFICE OF PUBLIC RECORDS

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To the Honorable Commission	er of Patents and Trademarks: I		-	أبه ليها والمنطب ومناهم ومناهم المناهم المناهم ومناهم المناهم والمناهم والم
1. Name of conveying party(ies):		2. Name and	d Address of rece	eiving party(ies)
MICRON CUSTOM MANUFAC	TURING SERVICES, INC.	MCMS, IN		
Additional name(s) of conveying party(ies)	attached? Yes X No	16399 Fra Nampa, Id	nklin Road aho 83687	
3. Nature of conveyance:				
Assignment	Merger			
Security Agreement	X Change of Name			
Other	,	Additional na	ame(s) & address(es)	attached? Yes X No
Execution Date: February 18, 19	98			
4. Application number(s) or patent r	number(s):			
If this document is being filed together	ether with a new application, the	e execution date	e of the application	on is:
A. Patent Application No.(s)		B. Patent	No.(s)	
See attached Schedule B		See	Attached Schedu	ule A
	Additional numbers attach	ed? X Yes	No	
5. Name and address of party to who concerning document should be m		6. Total nur	nber of application	ons and patents involved: 42
Hayley M. Smith, Legal Assistan	ıt	7. Total fee	(37 CFR 3.41)	\$ _1,680.00_
Kirkland & Ellis Citicorp Center		_X En	closed	
153 East 53rd Street New York, New York 10022				athorized to be charged to
(212) 446-4727		Dep	posit Account No	. 11-1098
(,		8 Cha	rge to Deposit A	ecount No. 11-1098
/29/1996 TTOM11 00000075 4885841		(Attach dup	licate copy of this pa	ge if paying by deposit account)
FC:581 1680.0	DO NOT USE	<del></del>		
9. Statement and signature.  To the best of my knowledge and the original document.  Debra B. Arenare, Esq.  Name of Person Signing	belief, the foregoing information	)	rrect and any atta	April 21, 1998 Date
Tota	il number of pages including cover she	et, attachments, an	nd document:7	
CONTROL OF DATENES AND TRADES				

COMMISSIONER OF PATENTS AND TRADEMARKS BOX ASSIGNMENTS-WASHINGTON D.C. 20231

# SCHEDULE A TO RECORDATION FORM COVER SHEET

# **ISSUED PATENTS**

TITLE	PATENT NO.	ISSUE DATE
Vibrational method of aligning the leads of surface mount electronic components with the mounting pads of printed circuit boards during the mollen solder mounting process	4,885,841	December 12, 1989
Semiconductor pick and place machine calibration apparatus	5,247,844	September 28, 1993
Semiconductor pick and place machine calibration apparatus	5,237,622	August 17, 1993
Fixture for alignment of vacuum nozzles on semiconductor manufacturing equipment	5,433,013	July 18, 1995
Method employing an elevating of atmospheric pressure during the heating and/or cooling phases of ball grid array (BGA) soldering oaf an IC device to a PCB	5,385,291	January 31, 1995
Fixture for alignment of vacuum nozzles on semiconductor manufacturing equipment	5,539,992	July 30, 1996
Automatic optical pick and place calibration and capability analysis system for assembly of components onto printed circuit boards	5,537,204	July 16, 1996
Angled pallets for wave soldering	5,540,376	July 30, 1996
Shield and method for selective wave soldering	5,617,990	April 8, 1997
Module handling apparatus and method with rapid switchover capability	5,667,077	September 16, 1997
Shield and method for selective wave soldering	5,704,535	January 6, 1998

# SCHEDULE B TO RECORDATION FORM COVER SHEET

# PATENT APPLICATIONS

TITLE	A DDI ICA TIONANO	
	APPLICATION NO.	FILING DATE
Air Bladder Fixture Tooling for Supporting Circuit Board Assembly Processing	08/800,069	February 12, 1997
Improved Actuator Stem and Actuator Design	08/602,346	February 16, 1996
Spring Roll Pins for Printed Circuit Board Routing	08/410,388	July 29, 1993
Wave Solder Method for Attaching Components to a Printed Circuit Board	08/686,781	July 25, 1996
Thermal Box for a Semiconductor Test System	08/553,763	October 23, 1995
Module Handling Apparatus and Method with Rapid Switchover Capabilities	08/891,954	July 14, 1997
Universal Testing Device	08/712,371	September 11, 1996
Fixture for Testing and Prepping Light- Emitting Diodes	08/695,613	August 12, 1996
Method and Apparatus for Depositing Solder and Adhesive Materials onto a Printed Circuit Board	08/706,448	September 3, 1996
Salvage Method and Apparatus for Recovering Microelectronic Components from Printed Circuit Boards	08/775,664	December 31, 1996
Universal Fixture for Holding Printed Circuit Boards During Processing	08/761,701	December 6, 1996
Method and Apparatus for Preserving Solder Paste in the Manufacturing of Printed Circuit Board Assemblies	08/772.155	December 20, 1996
Method and Apparatus for Coupling Together Printed Circuit Boards	08/773,624	December 20, 1996
Electronic Component Connecting Tool and Method	08/855,092	May 13, 1997
Apparatus for Using a Damage IC	08/885,315	June 30, 1997

# SCHEDULE B TO RECORDATION FORM COVER SHEET

TITLE	APPLICATION NO.	FILING DATE
Method of Using a Damaged IC	08/885,670	June 30, 1997
Apparatus for Bending Component Leads	08/918,613	August 22, 1997
Method for Bending Component Leads	08/916,691	August 22, 1997
Universal Fixture for Supporting and Holding Populated Sides of Printed Circuit Board Assemblies during Processing	08/833,914	April 10, 1997
Apparatus for Calibrating Surface Mounting Processes in Printed Circuit Board Assembly Manufacturing	08/895,765	July 17, 1997
Method for Calibrating Surface Mounting Processes in Printed Circuit Board Assembly Manufacturing	08/895,766	July 17, 1997
Apparatus for Holding Printed Circuit Board Assemblies in Manufacturing	08/882,479	June 25, 1997
Method for Holding Printed Circuit Board Assemblies in Manufacturing	08/882,480	June 25, 1997
Alignment Fixture for Solder-Wave Machine	08/852,335	May 2, 1997
Solder Paste Brick	08/897,093	July 18, 1997
Method of Attaching a Device to a Circuit Board	08/896,412	July 18, 1997
Apparatus for Supporting Printed Circuit Board Assemblies	08/925,188	September 8, 1997
Method for Supporting Printed Circuit Board Assemblies	08/926,139	September 8, 1997
Improved Carrier Socket for Receiving a Damaged IC	08/919,626	August 28, 1997
Improved Carrier Socket for Receiving a Damaged IC	08/919,536	August 28, 1997
High Speed Interface for Testing Semiconductor Components	08/924,278	September 8, 1997

# State of Idaho

# **Department of State**

I, PETE T. CENARRUSA, Secretary of State of the State of Idaho, hereby certify that I am the custodian of the corporation records of this State.

I FURTHER CERTIFY That the annexed is a full, true and complete transcript of articles of amendment of MCMS, INC., an Idaho corporation, changing its name from MICRON CUSTOM MANUFACTURING SERVICES, INC., received and filed in this office on February 18, 1998, under file number C 108686, as appears of record in this office as of this date.

Dated: March 4, 1998



Fite of Generical SECRETARY OF STATE

#### CERTIFICATE OF AMENDMENT OF

#### ARTICLES OF INCORPORATION OF

## MICRON CUSTOM MANUFACTURING SERVICES, INC.

The undersigned, Jess Asla and Dena Banducci, certify that:

- They are the duly elected Vice President, Operations and Secretary, respectively, of Micron Custom Manufacturing Services, Inc., an Idaho corporation (the "Corporation").
- 2. Article I of the Articles of Incorporation of the Corporation is hereby amended to read as follows:

"The name of the Corporation is: MCMS, Inc."

- The foregoing Amendment of the Articles of Incorporation has been duly approved by the Board of Directors of the Corporation by unanimous written consent effective as of February 18, 1998.
- 4. The foregoing Amendment of the Articles of Incorporation has been duly approved by the holders of all of the outstanding shares of common stock of the Corporation by unanimous written consent effective as of February 18, 1998.

We further declare under penalty of perjury under the laws of the State of Idaho that the matters set forth in this amendment are true and correct to our own knowledge.

Date: February 18, 1998

Jess Asla, Vice President, Operations

Dena Banducci, Secretary

## ACTION BY WRITTEN CONSENT OF

## THE SOLE SHAREHOLDER OF

### MICRON CUSTOM MANUFACTURING SERVICES, INC.

The undersigned, being the sole shareholder of Micron Custom Manufacturing Services, Inc. (the "Corporation"), in accordance with the Bylaws of the Corporation and the Idaho Business Corporation Act, hereby adopts the following resolution:

That Article I of the Articles of Incorporation of the Corporation is Resolved: amended to read in full as follows:

"The name of the Corporation is: MCMS, Inc."

That the Corporation is authorized to take all such actions Resolved Further: as are necessary or advisable in order to carry out the intent of the foregoing resolution.

In witness whereof, the undersigned has executed this Consent as of the 18th day of February, 1998.

**RECORDED: 02/23/1999** 

MEI CALIFORNIA, INC.

**PATENT** 

**REEL: 9777 FRAME: 0404**